# onsemi

# <u>Silicon Carbide (SiC)</u> <u>MOSFET</u> – 20 mohm, 1200 V, M1, TO-247-3L

# NVHL020N120SC1

## Features

- Typ.  $R_{DS(on)} = 20 \text{ m}\Omega$
- Ultra Low Gate Charge (typ.  $Q_{G(tot)} = 203 \text{ nC}$ )
- Low Effective Output Capacitance (typ. Coss = 260 pF)
- 100% UIL Tested
- AEC-Q101 Qualified and PPAP Capable
- This Device is Halide Free and RoHS Compliant with exemption 7a, Pb–Free 2LI (on second level interconnection)

# **Typical Applications**

- Automotive On Board Charger
- Automotive DC-DC converter for EV/HEV

## MAXIMUM RATINGS (T<sub>J</sub> = 25°C unless otherwise noted)

Parameter		Symbol	Value	Unit	
Drain-to-Source Voltage		V <sub>DSS</sub>	1200	V	
Gate-to-Source Voltage		V <sub>GS</sub>	V <sub>GS</sub> -15/+25		
Recommended Opera- tion Values of Gate-to- Source Voltage	T <sub>C</sub> < 175°C		V <sub>GSop</sub>	-5/+20	V
$\begin{array}{l} \text{Continuous Drain} \\ \text{Current } R_{\theta JC} \end{array}$	Steady State	$T_{\rm C} = 25^{\circ}{\rm C}$	Ι <sub>D</sub>	103	A
Power Dissipation $R_{\theta JC}$			PD	535	W
Continuous Drain Current $R_{\theta JC}$	Steady State	$T_C = 100^{\circ}C$	۱ <sub>D</sub>	73	A
Power Dissipation $R_{\theta JC}$			PD	267	W
Pulsed Drain Current (Note 2)	$T_A = 25^{\circ}C$		I <sub>DM</sub>	412	А
Single Pulse Surge Drain Current Capability	$\begin{array}{l} T_{A} = 25^{\circ}C,  t_{p} = 10 \; \mu s, \\ R_{G} = 4.7 \; \Omega \end{array}$		I <sub>DSC</sub>	807	А
Operating Junction and Storage Temperature Range		T <sub>J</sub> , T <sub>stg</sub> –55 to +175		°C	
Source Current (Body Diode)		IS	54	А	
Single Pulse Drain-to-Source Avalanche Energy ( $I_{L(pk)} = 23 \text{ A}, L = 1 \text{ mH}$ ) (Note 3)		E <sub>AS</sub>	264	mJ	

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### THERMAL RESISTANCE MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
Junction-to-Case (Note 1)	$R_{\theta JC}$	0.28	°C/W
Junction-to-Ambient (Note 1)	$R_{\theta JA}$	40	°C/W

1. The entire application environment impacts the thermal resistance values shown, they are not constants and are only valid for the particular conditions noted.

2. Repetitive rating, limited by max junction temperature.

3. E<sub>AS</sub> of 264 mJ is based on starting T<sub>J</sub> = 25°C; L = 1 mH, I<sub>AS</sub> = 23 A, V<sub>DD</sub> = 120 V, V<sub>GS</sub> = 18 V.

V <sub>(BR)DSS</sub>	R <sub>DS(on)</sub> MAX	I <sub>D</sub> MAX
1200 V	28 mΩ @ 20 V	103 A

# **N-CHANNEL MOSFET**





#### MARKING DIAGRAM



#### **ORDERING INFORMATION**

Device	Package	Shipping
NVHL020N120SC1	TO247-3L	30 Units / Tube

### **ELECTRICAL CHARACTERISTICS**

Parameter	Symbol	Test Conditions	Min	Тур	Max	Unit
OFF CHARACTERISTICS						
Drain-to-Source Breakdown Voltage	V <sub>(BR)DSS</sub>	V <sub>GS</sub> = 0 V, I <sub>D</sub> = 1 mA	1200	-	-	V
Drain-to-Source Breakdown Voltage Temperature Coefficient	V <sub>(BR)DSS</sub> /T <sub>J</sub>	$I_D = 1$ mA, referenced to $25^{\circ}C$	-	900	-	mV/°C
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	$V_{GS}$ = 0 V, $V_{DS}$ = 1200 V, $T_J$ = 25 $^\circ C$	-	-	100	μA
		$V_{GS}$ = 0 V, $V_{DS}$ = 1200 V, $T_{J}$ = 175°C	-	-	250	
Gate-to-Source Leakage Current	I <sub>GSS</sub>	$V_{GS}$ = +25/-15 V, $V_{DS}$ = 0 V	-	-	±1	μΑ
ON CHARACTERISTICS						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{GS} = V_{DS}, I_D = 20 \text{ mA}$	1.8	2.7	4.3	V
Recommended Gate Voltage	V <sub>GOP</sub>		-5	-	+20	V
Drain-to-Source On Resistance	R <sub>DS(on)</sub>	$V_{GS}$ = 20 V, $I_{D}$ = 60 A, $T_{J}$ = 25 $^{\circ}C$	-	20	28	mΩ
		$V_{GS}$ = 20 V, I <sub>D</sub> = 60 A, T <sub>J</sub> = 175°C	-	35	50	
Forward Transconductance	<b>9</b> FS	V <sub>DS</sub> = 10 V, I <sub>D</sub> = 60 A	-	28	-	S
CHARGES, CAPACITANCES & GATE	RESISTANCE					
Input Capacitance	C <sub>ISS</sub>	$V_{GS}$ = 0 V, f = 1 MHz, $V_{DS}$ = 800 V	-	2890	-	pF
Output Capacitance	C <sub>OSS</sub>		-	260	-	
Reverse Transfer Capacitance	C <sub>RSS</sub>		-	22	-	1
Total Gate Charge	Q <sub>G(tot)</sub>	$V_{GS} = -5/20$ V, $V_{DS} = 600$ V, $I_D = 80$ A	-	203	-	nC
Threshold Gate Charge	Q <sub>G(th)</sub>		-	33	-	
Gate-to-Source Charge	Q <sub>GS</sub>		-	66	-	
Gate-to-Drain Charge	Q <sub>GD</sub>		-	47	-	
Gate Resistance	R <sub>G</sub>	f = 1 MHz	-	1.81	-	Ω
SWITCHING CHARACTERISTICS		· · · · · ·				
Turn-On Delay Time	t <sub>d(on)</sub>	$V_{GS} = -5/20 \text{ V}, \text{ V}_{DS} = 800 \text{ V},$	-	25	-	ns
Rise Time	t <sub>r</sub>	$I_D = 80 \text{ A}, \text{ R}_G = 2 \Omega,$ Inductive Load	-	57	-	-
Turn-Off Delay Time	t <sub>d(off)</sub>		-	45	-	
Fall Time	t <sub>f</sub>		-	11	-	
Turn-On Switching Loss	E <sub>ON</sub>		-	2718	-	μJ
Turn-Off Switching Loss	E <sub>OFF</sub>		-	326	-	1
Total Switching Loss	E <sub>TOT</sub>		-	3040	-	
DRAIN-SOURCE DIODE CHARACTEI	RISTICS	· · · · · ·				
Continuous Drain-to-Source Diode Forward Current	I <sub>SD</sub>	$V_{GS}$ = -5 V, T <sub>J</sub> = 25°C	-	-	54	A
Pulsed Drain-to-Source Diode Forward Current (Note 2)	I <sub>SDM</sub>	$V_{GS}$ = -5 V, $T_J$ = 25°C	-	-	412	A
Forward Diode Voltage	V <sub>SD</sub>	$V_{GS}$ = -5 V, I <sub>SD</sub> = 30 A, T <sub>J</sub> = 25°C	-	3.7	-	V
Reverse Recovery Time	t <sub>RR</sub>	$V_{GS} = -5/20 \text{ V}, I_{SD} = 80 \text{ A},$ dI <sub>S</sub> /dt = 1000 A/µs	-	31	-	ns
Reverse Recovery Charge	Q <sub>RR</sub>		_	240	_	nC
Reverse Recovery Energy	E <sub>REC</sub>		-	10	-	μJ
Peak Reverse Recovery Current	I <sub>RRM</sub>	1	_	15	_	A

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

# **TYPICAL CHARACTERISTICS**



### TYPICAL CHARACTERISTICS (continued)



# TYPICAL CHARACTERISTICS (continued)



Figure 13. Junction-to-Ambient Thermal Response



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